## MOSFET – Power, N-Channel, SUPERFET<sup>®</sup> III, Easy Drive

## 650 V, 75 A, 23 m $\Omega$

#### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

#### Features

- 700 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 19.5 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 222 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 1980 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

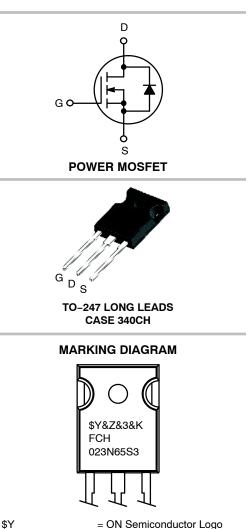
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



## **ON Semiconductor®**

#### www.onsemi.com

V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
650 V	23 mΩ @ 10 V	75 A	



&Z= Assembly Plant Code&3= Data Code (Year & Week)&K= Lot

FCH023N65S3 = Specific Device Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit		
V <sub>DSS</sub>	Drain to Source Voltage		650	V	
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±30	V	
		– AC (f > 1 Hz)	±30		
I <sub>D</sub>	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	75	А	
		– Continuous (T <sub>C</sub> = 100°C)	65.8	1	
I <sub>DM</sub>	Drain Current	– Pulsed (Note 1)	300	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	Surrent (Note 2)		mJ	
I <sub>AS</sub>	Avalanche Current (Note 2)			А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		20		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	595	W	
	– Derate Above 25°C		4.76	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse width limited by maximum junction temperature. 2.  $I_{AS} = 15 \text{ A}, \text{ R}_{G} = 25 \Omega$ , starting  $T_{J} = 25^{\circ}\text{C}$ . 3.  $I_{SD} \leq 37.5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \leq 400 \text{ V}$ , starting  $T_{J} = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH023N65S3-F155	FCH023N65S3	TO-247 G03	Tube	N/A	N/A	30 Units

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
OFF CHARACT	ERISTICS						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650	-	-	V	
		$V_{GS}$ = 0 V, $I_{D}$ = 1 mA, $T_{J}$ = 150°C	700	-	-	V	
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$	-	0.72	_	V/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ	
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	6.8	-		
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30$ V, $V_{DS} = 0$ V	-	-	±100	nA	
N CHARACTE	RISTICS						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 3.0 \text{ mA}$	2.5	-	4.5	V	
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 37.5 A	-	19.5	23	mΩ	
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 37.5 A	-	66	-	S	

#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
	ARACTERISTICS					<u> </u>
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz	_	7160	-	pF
C <sub>oss</sub>	Output Capacitance	1 – – – – – –	_	195	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	1980	-	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	298	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 37.5 A, V <sub>GS</sub> = 10 V (Note 4)	-	222	-	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		-	54	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	90	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.9	-	Ω
WITCHING C	HARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 37.5 \text{ A},$	-	45	-	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>g</sub> = 2 Ω (Note 4)	-	55	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	140	-	ns
t <sub>f</sub>	Turn-Off Fall Time		_	29	-	ns
OURCE-DRA	IN DIODE CHARACTERISTICS					
۱ <sub>S</sub>	Maximum Continuous Drain to Source	Diode Forward Current	_	-	75	А
				1	Í	

IS Maximum Continuous Drain to Source Diode Forward Current		-	-	75	A	
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	300	А
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS}$ = 0 V, $I_{SD}$ = 37.5 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 37.5 \text{ A}, \text{ dI}_{\text{F}}/\text{dt} = 100 \text{ A}/\mu\text{s}$	-	600	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	17.9	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

## **TYPICAL PERFORMANCE CHARACTERISTICS**

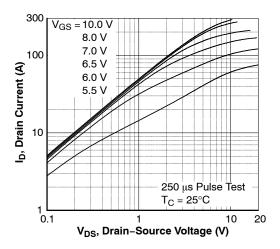


Figure 1. On–Region Characteristics

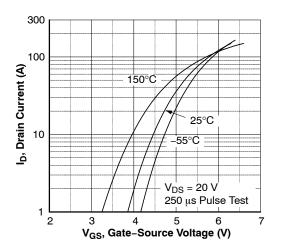


Figure 2. Transfer Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

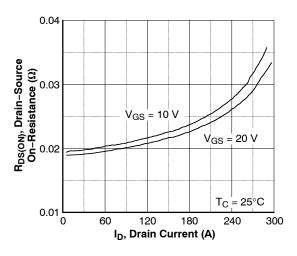


Figure 3. On–Resistance Variation vs.Drain Current and Gate Voltage

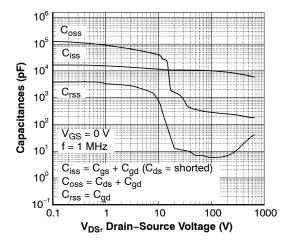
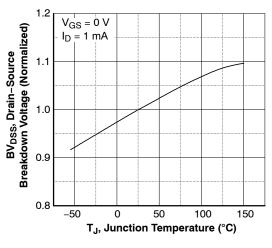
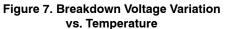


Figure 5. Capacitance Characteristics





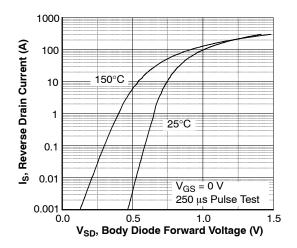


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

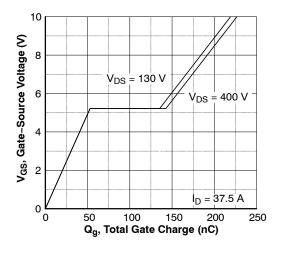
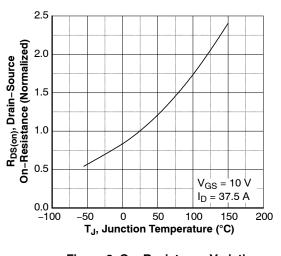


Figure 6. Gate Charge Characteristics





#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

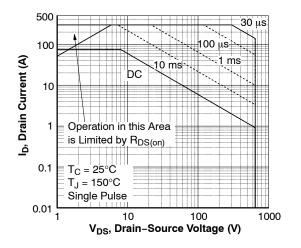


Figure 9. Maximum Safe Operating Area

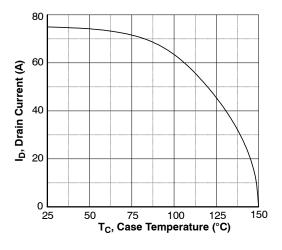


Figure 10. Maximum Drain Current vs. Case Temperature

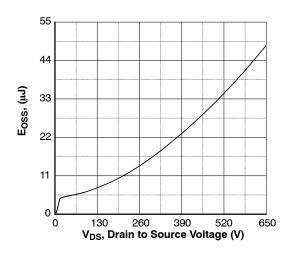


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

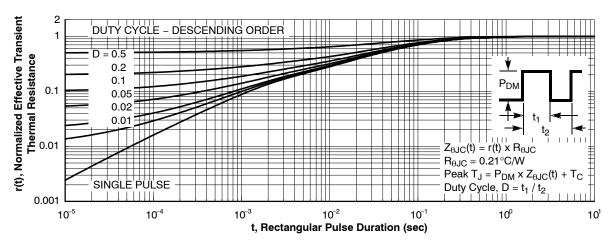
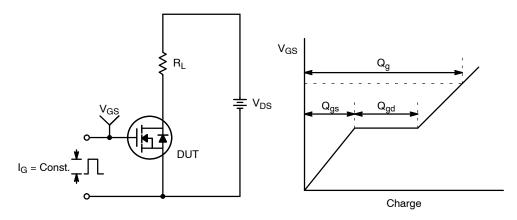


Figure 12. Transient Thermal Response Curve





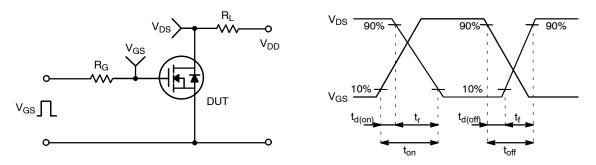
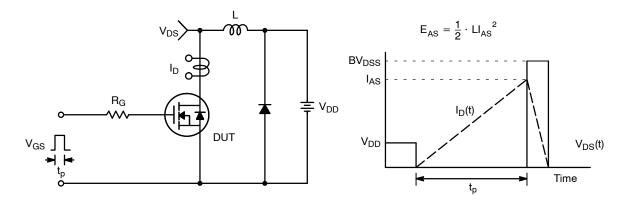


Figure 14. Resistive Switching Test Circuit & Waveforms





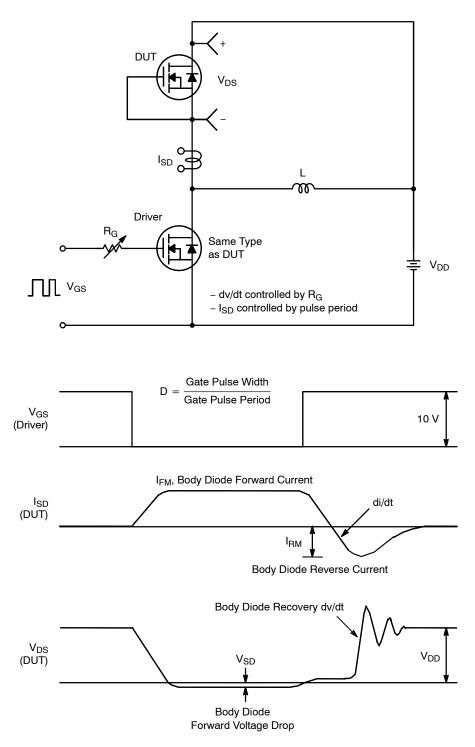
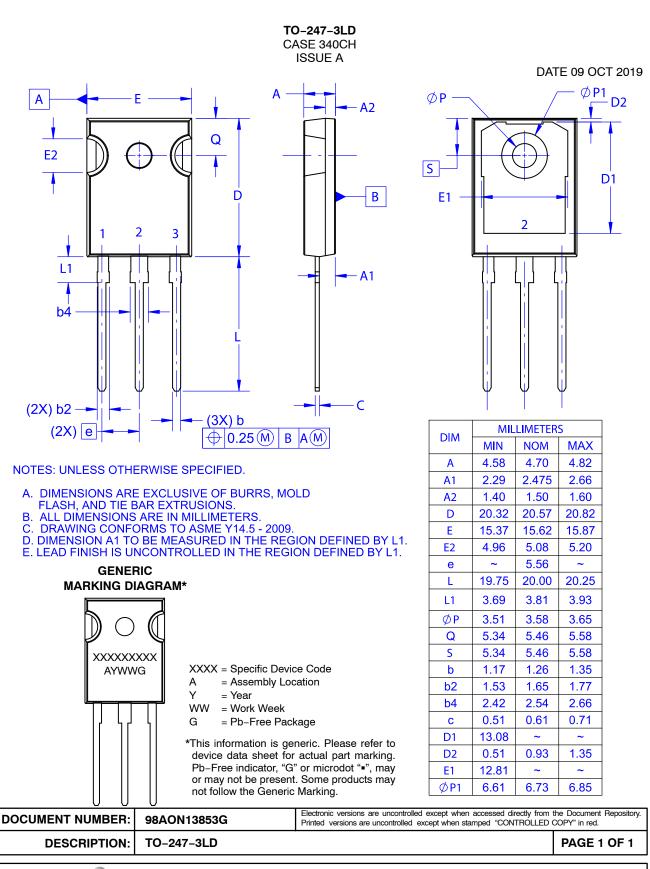


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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